

# Application Brief

## BAW Oscillator Solutions for Motor Drivers



Eshaan Tibrewala

### BAW Resonator Technology

BAW is a micro-resonator technology that enables the integration of high-precision and ultra-low jitter clocks directly into packages that contain other circuits. In the BAW oscillator, the BAW is integrated with a co-located precision temperature sensor, a ultra-low jitter, low power fractional output divider (FOD), a single-ended LVCMOS and differential LVPECL, LVDS, and HCSL output driver, and a small power-reset-clock management system consisting of several low noise LDOs.

Figure 1 shows the structure of the BAW resonator technology. The structure includes a thin layer of piezoelectric film sandwiched between metal films and other layers that confine the mechanical energy. The BAW utilizes this piezoelectric transduction to generate a vibration.

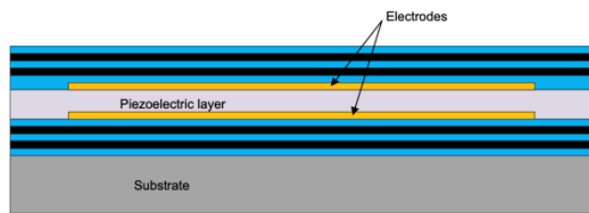


Figure 1. Basic Structure of a Bulk Acoustic Wave (BAW) Resonator

### BAW Oscillator in Motor Drive Systems

Motor drive systems are used in many industrial and manufacturing applications. The systems require precise control of position, torque, and speed for robust and reliable performance. Many applications such as AC inverter and VF drives, single and multi-axis servo drives, and stepper drives rely on EtherCAT® to transmit data to the host processor, which requires a reliable clocking architecture to achieve the best performance. Figure 2, Figure 3, and Figure 4 show common clocking architectures for standard EtherCAT applications.

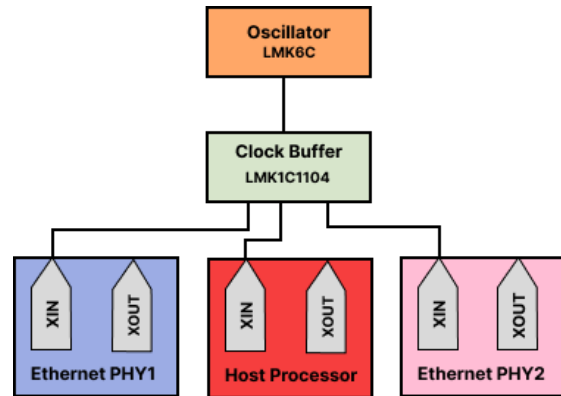


Figure 2. Topology 1

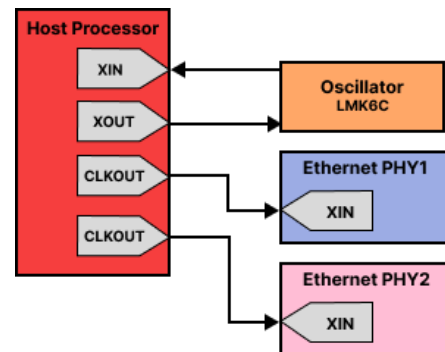


Figure 3. Topology 2

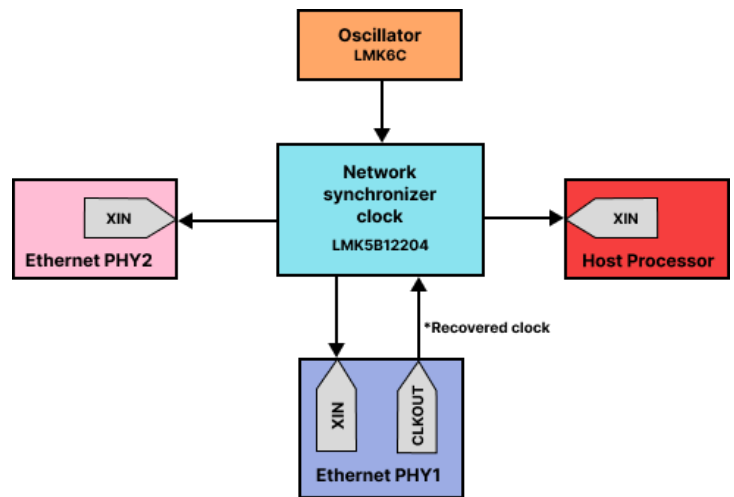
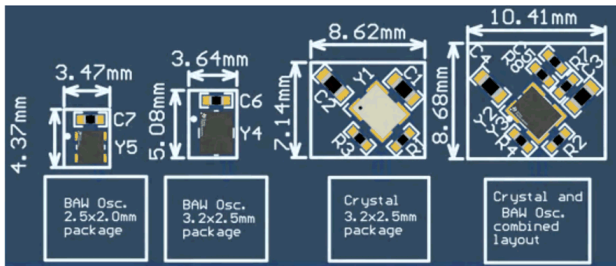


Figure 4. Topology 3

## Benefits of the BAW Oscillator

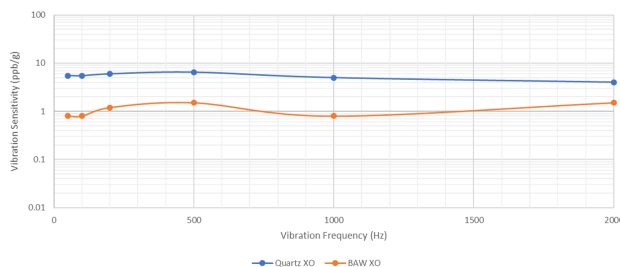
TI's BAW oscillators have many benefits including the following:

- BAW oscillators are available in small package sizes (3.2 mm × 2.5 mm and 2.5 mm × 2.0 mm) and do not require the additional capacitors that crystals require, which allows for reduced PCB space that is allocated to the oscillator. **Figure 5** shows how using a BAW oscillator can help save PCB space.



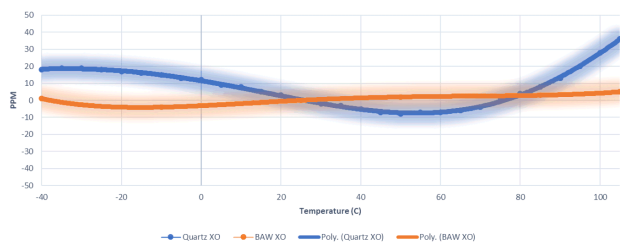
**Figure 5. PCB Footprint Comparison of BAW Oscillator and Crystal**

- BAW technology enables high resiliency to harsh environmental conditions, such as mechanical shock and vibration and achieves 100× better MTBF compared to quartz based designs. As shown in **Figure 6**, BAW oscillators experience only 1 ppb/g vibration sensitivity, which is 10× better than quartz-based designs.



**Figure 6. BAW Oscillator Vibration Sensitivity**

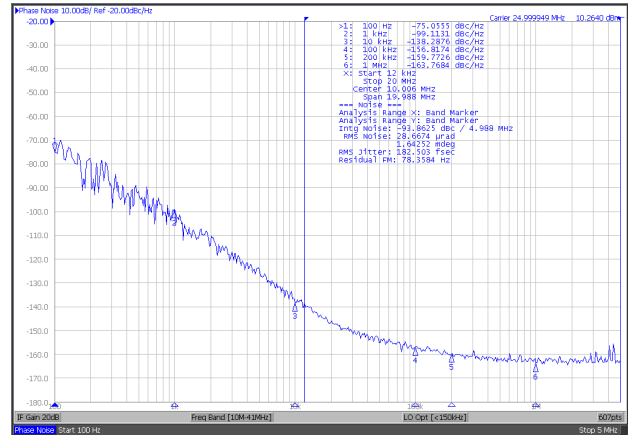
- BAW oscillators maintain a temperature stability of ±10 ppm over temperature from -40 to +105°C.



**Figure 7. Temperature Stability Comparison of BAW Oscillator and Quartz**

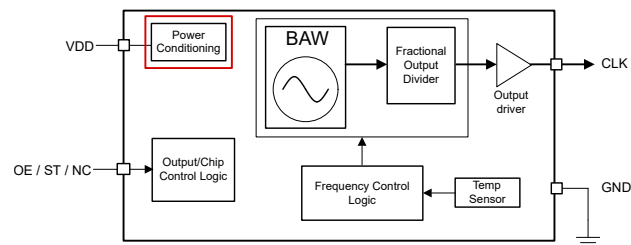
- LMK6C oscillators support a RMS jitter of 250 fs (typical), resulting in optimized BER performance

and improved synchronization between the processor and Ethernet PHY.



**Figure 8. LMK6C BAW Oscillator 25-MHz Phase Noise Performance**

- BAW oscillators include an integrated LDO which provides high-power supply noise immunity.



**Figure 9. LMK6 BAW Simplified Block Diagram with Integrated LDO**

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2023, Texas Instruments Incorporated